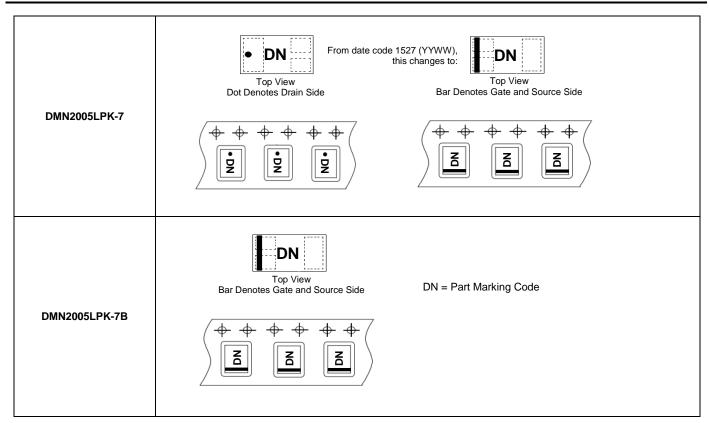


Marking Information





Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	20	V
Gate-Source Voltage		V _{GSS}	±10	V
Drain Current per element (Note 5)	Continuous Pulsed (Note 6)	I _D	300 350	mA

Thermal Characteristics (@TA = +25°C unless otherwise specified.)

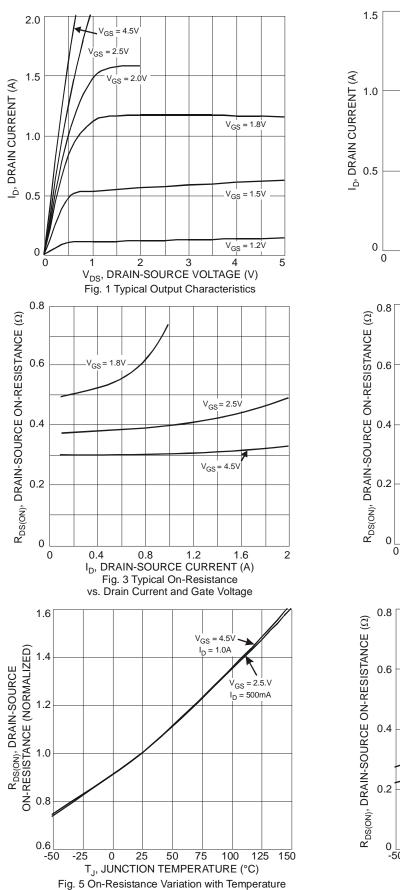
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P_{D}	400	mW
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	280	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

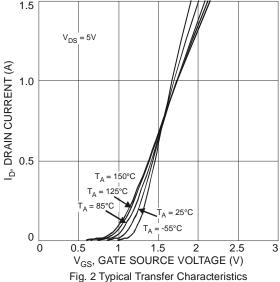
Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (per element) (Note 7)							
Drain-Source Breakdown Voltage		BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 100\mu A$
Zero Gate Voltage Drain Current		I _{DSS}	_	_	10	μΑ	$V_{DS} = 17V$, $V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	_	_	±5	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (per element) (Note 7)							
Gate Threshold Voltage		V _{GS(th)}	0.53	_	0.9	V	$V_{DS} = V_{GS}$, $I_D = 100\mu A$
Static Drain-Source On-Resistance		R _{DS} (ON)		0.35 0.4 0.45 0.55 0.65	1.5 1.7 1.7 3.5 3.5	Ω	$V_{GS} = 4V$, $I_D = 10mA$ $V_{GS} = 2.7V$, $I_D = 200mA$ $V_{GS} = 2.5V$, $I_D = 10mA$ $V_{GS} = 1.8V$, $I_D = 200mA$ $V_{GS} = 1.5V$, $I_D = 1mA$
Forward Transfer Admittance		Y _{fs}	40	_	_	mS	$V_{DS} = 3V, I_D = 10mA$
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{iss}	_	37.1	_	pF	V _{DS} = 10V, V _{GS} = 0V f = 1.0MHz
Output Capacitance		Coss	_	6.5	_	pF	
Reverse Transfer Capacitance		C _{rss}	_	4.8	_	pF	
Switching Time	Turn-On Time Turn-Off Time	t _{on}	_	4.06 13.7		nS	$V_{DD} = 10V, R_I = 47\Omega, V_{GEN} = 4.5V,$ $R_{GEN} = 10\Omega.$

- 5. Device mounted on FR-4 PCB.
- 6. Pulse width ≤10µS, Duty Cycle ≤1%.
 7. Short duration pulse test used to minimize self-heating effect.







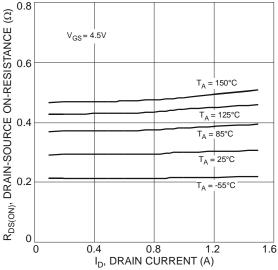


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

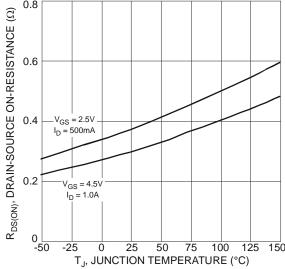


Fig. 6 On-Resistance Variation with Temperature



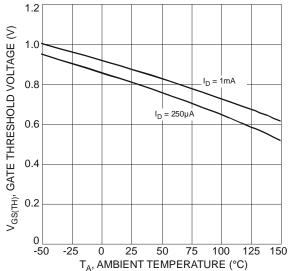
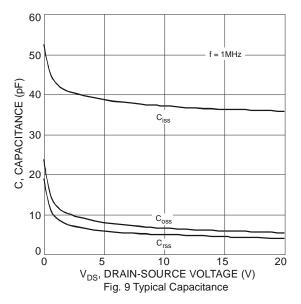
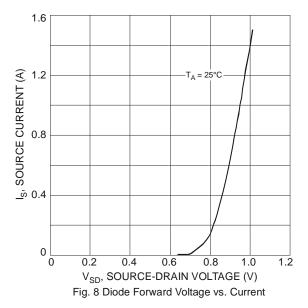


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

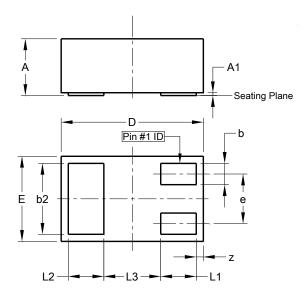






Package Outline Dimensions

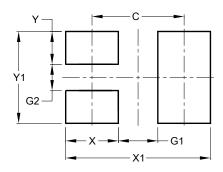
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40	l		
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е	1	1	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	-	-	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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